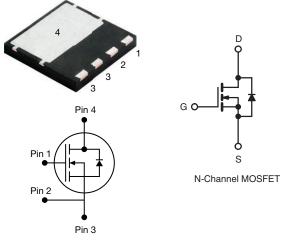




### **E Series Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.295				
Q <sub>g</sub> max. (nC)	62					
Q <sub>gs</sub> (nC)	7					
Q <sub>gd</sub> (nC)	13					
Configuration	Single					

#### PowerPAK<sup>®</sup> 8 x 8



#### FEATURES

- Fully lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH11N60E-T1-GE3

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V <sub>DS</sub>	600	V	
Gate-Source Voltage		V <sub>GS</sub>	± 30	v
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	I <sub>D</sub>	11	
	$T_{\rm C} = 100 ^{\circ}{\rm C}$		7	А
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	27	
Linear Derating Factor			0.9	W/°C
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	127	mJ
Maximum Power Dissipation		PD	114	W
Operating Junction and Storage Temperature	Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	dV/dt	70	V/ns
Reverse Diode dV/dt <sup>c</sup>	erse Diode dV/dt <sup>c</sup>		18	v/ns

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3 A.

c.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting  $T_J$  = 25 °C.

1





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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	42		55				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	0.76	0.76 1.10			°C/W		
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	nless otherwi	se noted)						
PARAMETER	SYMBOL		T CONDITIO	NS	MIN.	TYP.	MAX.	UNIT
Static						•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub>	= 1 mA	-	0.66	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		2.0	-	4.0	V	
		, v	$V_{\rm GS} = \pm 20  \rm V$		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>	, v	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
		V <sub>DS</sub> =	= 600 V, V <sub>GS</sub> =	0 V	-	-	1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	', V <sub>GS</sub> = 0 V, T	<sub>J</sub> = 125 °C	-	-	50	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> =	5.5 A	-	0.295	0.339	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 30 V, I <sub>D</sub> = 5.	5 A	-	3.7	-	S
Dynamic					•	•	•	
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	1076	-	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0.0$ V, $V_{DS} = 100$ V, f = 1 MHz		-	56	-	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	6	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V		-	52	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	174	-		
Total Gate Charge	Qg				-	31	62	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 5.5 A,	V <sub>DS</sub> = 480 V	-	7	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	13	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	16	32	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub> = 5.	5 A,	-	21	42	
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, R <sub>g</sub> = 9.		-	39	68	- ns
Fall Time	t <sub>f</sub>				-	21	42	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.2	0.7	1.5	Ω	
Drain-Source Body Diode Characteristic					•	•	•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	27	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 5.5 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>				-	280	560	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 \ ^{\circ}C, I_F = I_S = 5.5 \ A,$ dI/dt = 100 A/µs, V <sub>B</sub> = 25 V		-	3.0	6.0	μC	
, ,	<b>G</b> IL	dl/dt – 1	100 A/ire V	- 25 V		0.0	0.0	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

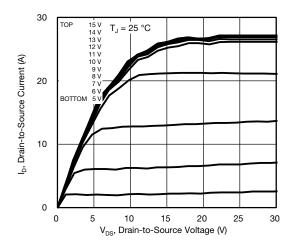
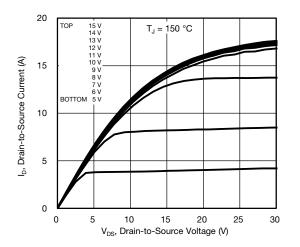
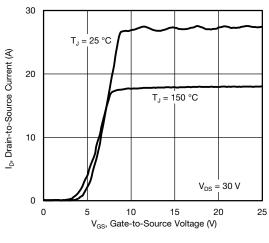


Fig. 1 - Typical Output Characteristics









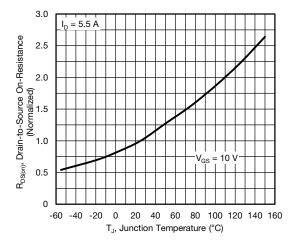


Fig. 4 - Normalized On-Resistance vs. Temperature

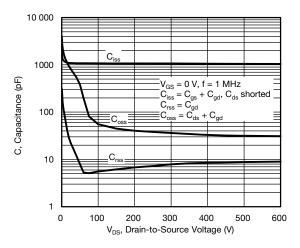


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

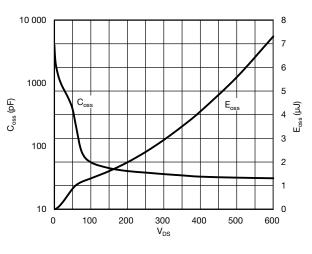


Fig. 6 -  $C_{\text{OSS}}$  and  $E_{\text{OSS}}$  vs.  $V_{\text{DS}}$ 

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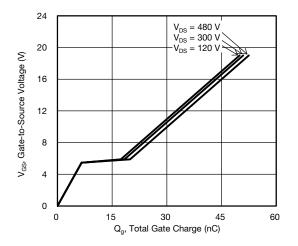


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

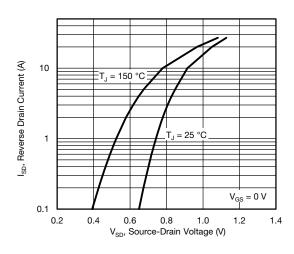


Fig. 8 - Typical Source-Drain Diode Forward Voltage

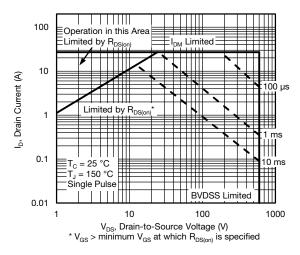


Fig. 9 - Maximum Safe Operating Area

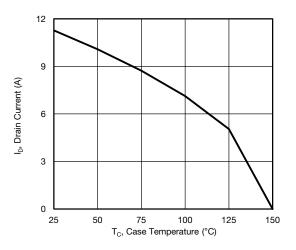


Fig. 10 - Maximum Drain Current vs. Case Temperature

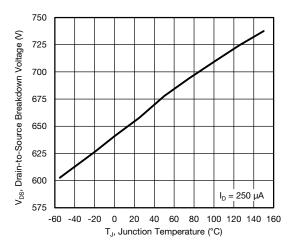
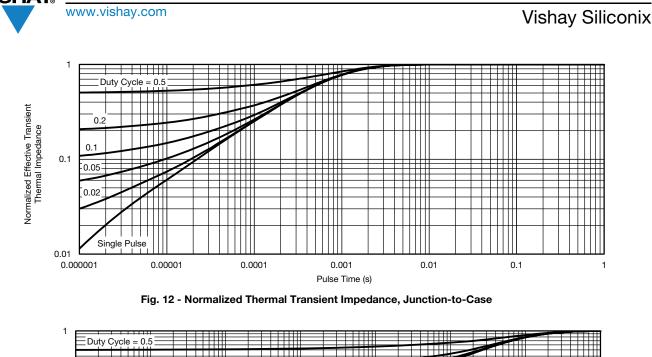


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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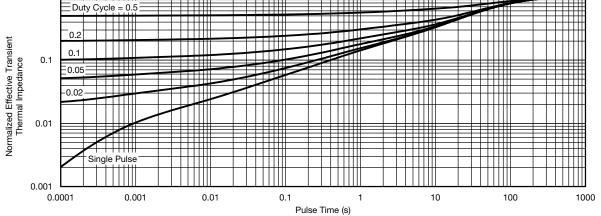


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

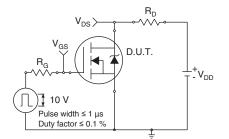


Fig. 14 - Switching Time Test Circuit

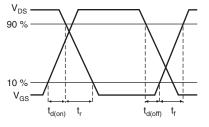
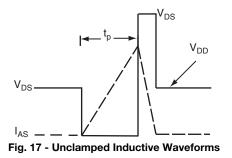


Fig. 15 - Switching Time Waveforms

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Vary  $t_p$  to obtain required  $I_{AS}$  $R_G$  $I_{AS}$  $I_{AS}$ I

Fig. 16 - Unclamped Inductive Test Circuit

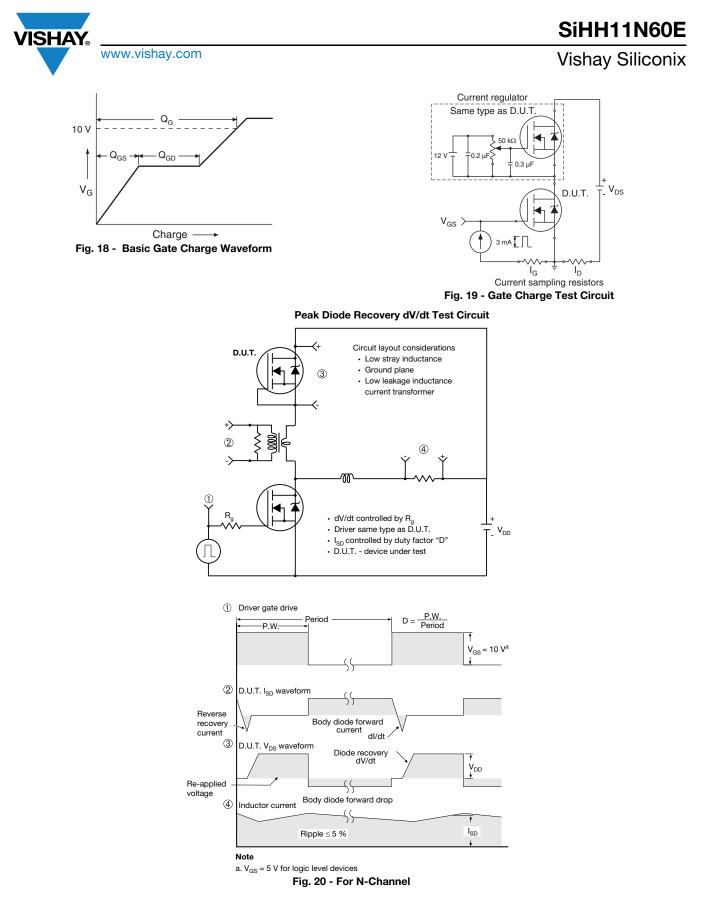


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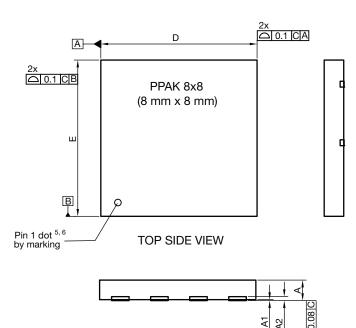


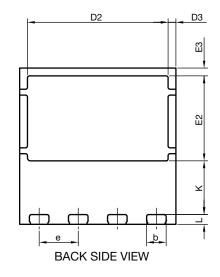
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM.		MILLIMETERS			INCHES	
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A <sup>8</sup>	0.95	1.00	1.05	0.037	0.039	0.041
A1	0.00	-	0.05	0.000	-	0.002
A2		020 ref.				
b <sup>4</sup>	0.95	1.00	1.05	0.037	0.039	0.041
D	7.90	8.00	8.10	0.311	0.315	0.319
D2	7.10	7.20	7.30	0.280	0.283	0.287
D3		0.40 BSC		0.016 BSC		
e		2.00 BSC		0.079 BSC		
E	7.90	8.00	8.10	0.311	0.315	0.319
E2	4.30	4.35	4.40	0.169	0.171	0.173
E3	0.40 BSC			0.016 BSC		
К		2.75 BSC		0.108 BSC		
L	0.45	0.50	0.55	0.018	0.020	0.022
N <sup>3</sup>		8		8		

D

#### Notes

1. Use millimeters as the primary measurement.

2. Dimensioning and tolerances conform to ASME Y14.5 M - 1994.

3. N is the number of terminals.

4. Package warpage max. 0.08 mm.

5. The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body.

6. Exact shape and size of this feature is optional.

ECN: T15-0225-Rev. A, 18-May-15 DWG: 6041

Revision: 18-May-15

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 

Document Number: 68441



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